

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5567034

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|---|---|
| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| CHAO-FENG CAI | 05/16/2019 |
| JIAN-HONG ZENG | 05/24/2019 |
| ZENG LI | 05/20/2019 |
| XIAO-NI XIN | 05/23/2019 |
| RECEIVING PARTY DATA | |
| Name: | DELTA ELECTRONICS, INC. |
| Street Address: | 31-1 XINGBANG ROAD, GUISHAN INDUSTRIAL ZONE |
| City: | TAOYUAN CITY |
| State/Country: | TAIWAN |
| Postal Code: | 33370 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 16436939 |
| CORRESPONDENCE DATA | |
| Fax Number: | (888)388-6582 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | (888)388-6609 |
| Email: | info@ckc-ip.com |
| Correspondent Name: | CKC & PARTNERS CO., LLC |
| Address Line 1: | 12345 LAKE CITY WAY NE, NO. 283 |
| Address Line 4: | SEATTLE, WASHINGTON 98125 |
| ATTORNEY DOCKET NUMBER: | TWT06616/US |
| NAME OF SUBMITTER: | JAMES LYNN O'SULLIVAN |
| SIGNATURE: | /James Lynn O'Sullivan/ |
| DATE SIGNED: | 06/11/2019 |
| Total Attachments: 6 | |
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ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) _____

SEMICONDUCTOR PACKAGING STRUCTURE

The PATENT RIGHTS referred to in this agreement are:

(check one) ☒ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

☐ U.S. patent application Serial No. _____, filed _____

☐ a U.S. patent application based on PCT International Application

No. _____ filed on (date) _____ (U.S. patent application Serial No. _____, if known).

☐ U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

☒ U.S. patent rights only.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) DELTA ELECTRONICS, INC.

(Address) 31-1 Xingbang Road, Guishan Industrial Zone, Taoyuan City 33370, Taiwan, R.O.C.

The ASSIGNEE is:

(check one) ☐ An individual

☐ A Partnership.

☒ A Corporation of TAIWAN, R.O.C. (specify state or country)

☐ (other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
ASSIGNEE: DELTA ELECTRONICS, INC.
INVENTION TITLE: SEMICONDUCTOR PACKAGING STRUCTURE

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Chao-Feng CAI

Name of sole or first inventor

Chao-feng Cai
Signature

May. 16. 2007
Date

Jian-Hong ZENG

Name of second inventor, if any

Signature

Date

Zeng Li

Name of third inventor, if any

Signature

Date

Xiao-Ni XIN

Name of fourth inventor, if any

Signature

Date

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| | | |
|---------------------------------|----------------|-------------------|
| <u>Chao-Feng CAI</u> | _____ | _____ |
| Name of sole or first inventor | Signature | Date |
| <u>Jian-Hong ZENG</u> | _____ | _____ |
| Name of second inventor, if any | Signature | Date |
| <u>Zeng Li</u> | <u>Zeng Li</u> | <u>2019-05-20</u> |
| Name of third inventor, if any | Signature | Date |
| <u>Xiao-Ni XIN</u> | _____ | _____ |
| Name of fourth inventor, if any | Signature | Date |

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| | | |
|---------------------------------|-----------------------|------------------|
| <u>Chao-Feng CAI</u> | _____ Signature | _____ Date |
| Name of sole or first inventor | | |
| <u>Jian-Hong ZENG</u> | <u>Jian-Hong ZENG</u> | <u>2019.5.24</u> |
| Name of second inventor, if any | Signature | Date |
| <u>Zeng Li</u> | _____ Signature | _____ Date |
| Name of third inventor, if any | | |
| <u>Xiao-Ni XIN</u> | <u>Xiao Ni Xin</u> | <u>2019.5.23</u> |
| Name of fourth inventor, if any | Signature | Date |